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October 2000

FDN5618P

FDN5618P

SEMICONDUCTOR IM

60V P-Channel Logic Level PowerTrench[®] MOSFET

General Description

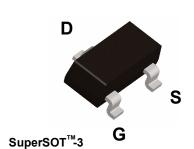
This 60V P-Channel MOSFET uses Fairchild's high voltage PowerTrench process. It has been optimized for power management applications.

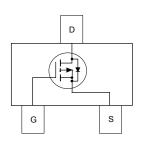
Applications

- DC-DC converters
- Load switch
- Power management

Features

- -1.25 A, -60 V. $R_{DS(ON)} = 0.170 \ \Omega \ @ V_{GS} = -10 \ V$ $R_{DS(ON)} = 0.230 \ \Omega \ @ V_{GS} = -4.5 \ V$
- Fast switching speed
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$





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Absolute Maximum Ratings T.=25% unless otherwi

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-60	V
V _{GSS}	Gate-Source Voltage		±20	V
ID	Drain Current – Continuous	(Note 1a)	-1.25	А
	– Pulsed		-10	
D	Maximum Power Dissipation	(Note 1a)	0.5	W
P _D		(Note 1b)	0.46	
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-55 to +150	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	250	°C/W

Package Marking and Ordering Information

Thermal Resistance, Junction-to-Case

Device Marking	Device	Reel Size	Tape width	Quantity
618	FDN5618P	7"	8mm	3000 units

(Note 1)

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 $R_{\theta JC}$

°C/W

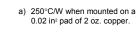
Symbol	Parameter	Test Conditions	Min	Тур	Мах	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	V_{GS} = 0 V, I_{D} = -250 μ A	-60			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = -250 µA,Referenced to 25°C		-58		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = -48 V$, $V_{GS} = 0 V$			-1	μA
I _{GSSF}	Gate–Body Leakage, Forward	$V_{GS} = 20V, \qquad V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	V _{GS} = -20 V V _{DS} = 0 V			-100	nA
On Char	acteristics (Note 2)				•	
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.6	-3	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = -250 µA,Referenced to 25°C		4		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$ \begin{array}{ll} V_{GS} = -10 \ V, & I_D = -1.25 \ A \\ V_{GS} = -4.5 \ V, & I_D = -1.0 \ A \\ V_{GS} = -10 \ V, \ I_D = -3 \ A \ T_J = 125^\circ C \end{array} $		0.148 0.185 0.245	0.170 0.230 0.315	Ω
I _{D(on)}	On-State Drain Current	$V_{GS} = -10 V$, $V_{DS} = -5 V$	-5			А
g _{FS}	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -1.25 A$		4.3		S
Dynamic	Characteristics					
Ciss	Input Capacitance	$V_{DS} = -30 V$, $V_{GS} = 0 V$,		430		pF
Coss	Output Capacitance	f = 1.0 MHz		52		pF
C _{rss}	Reverse Transfer Capacitance			19		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = -30 V$, $I_D = -1 A$,		6.5	13	ns
tr	Turn–On Rise Time	$V_{GS} = -10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		8	16	ns
t _{d(off)}	Turn–Off Delay Time			16.5	30	ns
t _f	Turn–Off Fall Time			4	8	ns
Qg	Total Gate Charge	$V_{DS} = -30 V$, $I_D = -1.25 A$,		8.6	13.8	nC
Q _{gs}	Gate-Source Charge	V _{GS} = -10 V		1.5		nC
Q _{gd}	Gate-Drain Charge			1.3		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
Is	Maximum Continuous Drain–Source	v			-0.42	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = -0.42$ (Note 2)		-0.7	-1.2	V

Notes:

1. $R_{\theta,JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta,JC}$ is guaranteed by design while $R_{\theta,CA}$ is determined by the user's board design.

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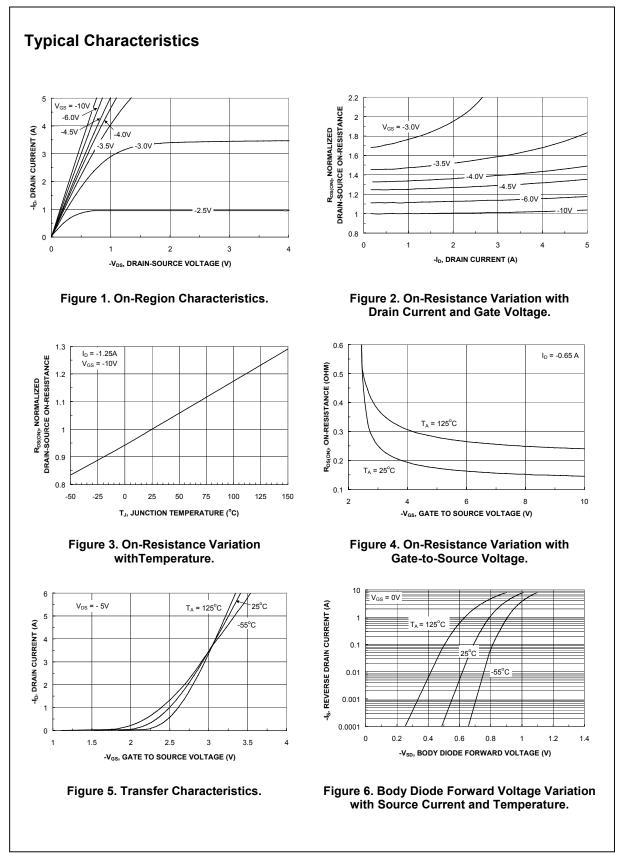
b) 270°C/W when mounted on a minimum pad.

6 Scale 1 : 1 on letter size paper

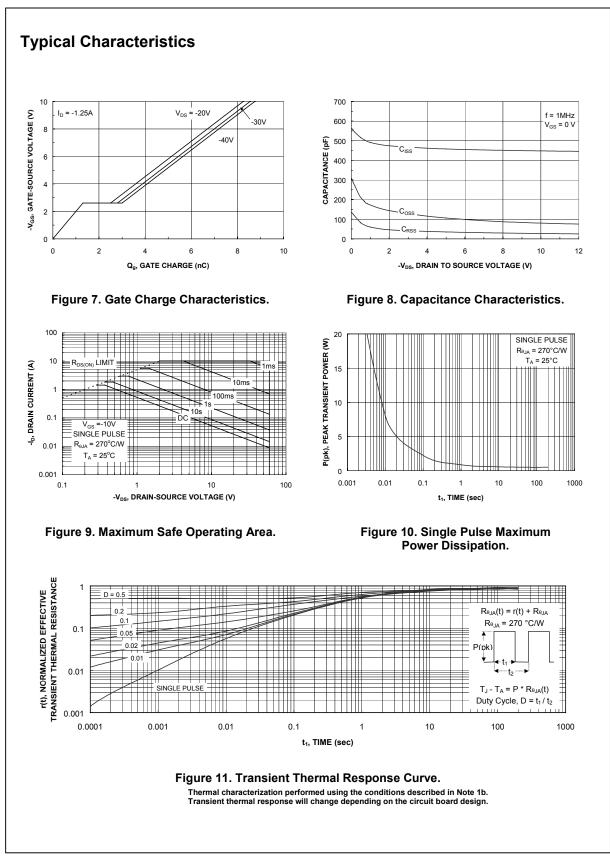
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2. Pulse Test: Pulse Width \leq 300 $\mu s,$ Duty Cycle \leq 2.0

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	•	Rev. F1

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